

Smart High-Side Power Switch 1 Channel: 1 x 200m Ω





Features

• Short circuit protection

- Current limitation
- Overload protection

Product Summary

Overvoltage protection	$V_{\rm bb(AZ)}$	47	V
Operating voltage	V _{bb(on)}	1245	V
On-state resistance	R _{ON}	200	mΩ

- Overvoltage protection (including load dump)
- Undervoltage shutdown with autorestart and hysteresis
- Switching inductive loads
- Clamp of negative voltage at output with inductive loads
- CMOS compatible input
- Thermal shutdown with restart
- ESD Protection
- Loss of GND and loss of V_{bb} protection
- Very low standby current
- Reverse battery protection with external resistor
- Improved electromagnetic compatibility (EMC)
- AEC qualified
- Green product (RoHS compliant)

Application

- All types of resistive, inductive and capacitive loads
- μC compatible power switch for 12 V and 24 V DC applications
- Replaces electromechanical relays and discrete circuits

4 2 1 VPS05163

PG-SOT-223

General Description

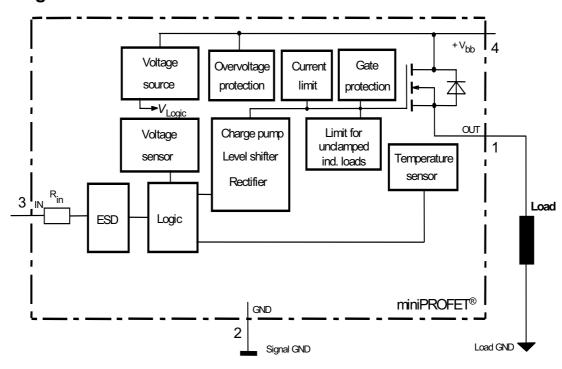
N channel vertical power FET with charge pump, ground referenced CMOS compatible input, monolithically integrated in Smart SIPMOS® technology.

Providing embedded protective functions.

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Block Diagram



Pin	Symbol	Function
1	OUT	Output to the load
2	GND	Logic ground
3	IN	Input, activates the power switch in case of logic high signal
4	Vbb	Positive power supply voltage

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Maximum Ratings

Parameter	Symbol	Value	Unit
at $T_j = 25$ °C, unless otherwise specified			
Supply voltage	$V_{\rm bb}$	-0,3 ¹⁾ 48	V
Continuous input voltage ²⁾	V_{IN}	-10 <i>V</i> _{bb}	
Load current (Short - circuit current, see page 5)	I _L	self limited	Α
Current through input pin (DC)	I _{IN}	±5	mA
Reverse current through GND-pin ³⁾	-I _{GND}	-0.5	Α
Operating temperature	Tj	internal limited	°C
Storage temperature	T _{stg}	-55 + 150	
Power dissipation ⁴⁾	P _{tot}	1.4	W
Inductive load switch-off energy dissipation ⁴⁾⁵⁾	E _{AS}	0.7	J
single pulse			
$T_{\rm j}$ = 125 °C, $I_{\rm L}$ = 0.5 A			
Load dump protection ⁵⁾ $V_{\text{LoadDump}}^{6} = V_{\text{A}} + V_{\text{S}}$	V _{Loaddump}		V
$R_{\rm I}$ =2 Ω , $t_{\rm d}$ =400ms, $V_{\rm IN}$ = low or high, $V_{\rm A}$ =13,5V	·		
R_{L} = 47 Ω		83	
Electrostatic discharge voltage (Human Body Model)	V _{ESD}		kV
according to ANSI EOS/ESD - S5.1 - 1993			
ESD STM5.1 - 1998			
Input pin		±1	
All other pins		±5	

¹defined by P_{tot}

150 Ω resistor in GND connection. A resistor for the protection of the input is integrated.

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 $^{^2}$ At V_{1N} > Vbb, the input current is not allowed to exceed ±5 mA.

³defined by P_{tot}

 $^{^4}$ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6 cm2 (one layer, 70 μ m thick) copper area for V_{bb} connection. PCB is vertical without blown air.

⁵not subject to production test, specified by design

 $^{^6}V_{
m Loaddump}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839 . Supply voltages higher than $V_{
m bb(AZ)}$ require an external current limit for the GND pin, e.g. with a



Electrical Characteristics

Parameter	Symbol		Values	;	Unit
at $T_{\rm j}$ = -40125 °C, $V_{\rm bb}$ = 1530 V unless otherwise specified		min.	typ.	max.	
Thermal Characteristics	,	•		•	
Thermal resistance @ min. footprint	$R_{th(JA)}$	-	-	125	K/W
Thermal resistance @ 6 cm ² cooling area ¹⁾	$R_{\rm th(JA)}$	-	-	70	
Thermal resistance, junction - soldering point	R _{thJS}	_	-	7	K/W
Load Switching Capabilities and Characteristics					
On-state resistance	R _{ON}				mΩ
$T_{\rm j}$ = 25 °C, $I_{\rm L}$ = 0.5 A		-	150	200	
T _j = 125 °C		-	270	320	
Nominal load current ²⁾	I _{L(nom)}	0.7	-	-	Α
Device on PCB 1)	,				
Turn-on time to 90% V _{OUT}	t_{on}				μs
$R_{\rm L}$ = 47 Ω , $V_{\rm IN}$ = 0 to 10 V		-	50	100	
Turn-off time to 10% V _{OUT}	$t_{\rm off}$				
$R_{\rm L}$ = 47 Ω , $V_{\rm IN}$ = 10 to 0 V		-	75	150	
Slew rate on 10 to 30% V _{OUT} ,	dV/dt _{on}				V/µs
$R_{L} = 47 \ \Omega, \ V_{bb} = 15 \ V$		-	1	2	
Slew rate off 70 to 40% V _{OUT} ,	-dV/dt _{off}		_		
$R_{\rm L}$ = 47 Ω , $V_{\rm bb}$ = 15 V		-	1	2	

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 $^{^{1}}$ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6 cm2 (one layer, 70 μ m thick) copper area for V_{bb} connection. PCB is vertical without blown air.

²Nominal load current is limited by the current limitation (see page 5)



Electrical Characteristics

Parameter	Symbol	Values			Unit
at $T_{\rm j}$ = -40125 °C, $V_{\rm bb}$ = 1530 V unless otherwise specified		min.	typ.	max.	
Operating Parameters	,			•	,
Operating voltage	V _{bb(on)}	12	-	45	V
Undervoltage shutdown	V _{bb(under)}	7	-	10.5	
Undervoltage restart	V _{bb(u rst)}	-	-	11	
Undervoltage hysteresis	$\Delta V_{\rm bb(under)}$	-	0.5	-	
$\Delta V_{\text{bb(under)}} = V_{\text{bb(u rst)}} - V_{\text{bb(under)}}$					
Standby current	I _{bb(off)}				μΑ
$T_{\rm j}$ = -4085 °C, $V_{\rm IN} \le 1.2 \text{ V}$		-	10	25	
$T_{\rm j} = 125 ^{\circ}{\rm C}^{1}$		-	-	50	
Operating current	I _{GND}	-	1	1.6	mA
Leakage output current (included in Ibb(off))	/ _{L(off)}	-	3.5	10	μA
$V_{\text{IN}} \leq 1.2 \text{ V}$, ,				
Protection Functions ²⁾					
Initial peak short circuit current limit	I _{L(SCp)}				Α
$T_{\rm j}$ = -40 °C, $V_{\rm bb}$ = 20 V, $t_{\rm m}$ = 150 $\mu {\rm s}$, , ,	-	-	2.1	
<i>T</i> _j = 25 °C		-	1.4	-	
<i>T</i> _j = 125 °C		0.7	-	-	
Repetitive short circuit current limit	I _{L(SCr)}	-	1.1	-	
T _j = T _{jt} (see timing diagrams)	, ,				
Output clamp (inductive load switch off)	V _{ON(CL)}	62	68	-	V
at $V_{\text{OUT}} = V_{\text{bb}} - V_{\text{ON(CL)}}$, $I_{\text{bb}} = 4 \text{ mA}$, ,				
Overvoltage protection 3)	V _{bb(AZ)}	47	-	-	
$I_{\rm bb} = 4 \text{ mA}$					
Thermal overload trip temperature ⁴⁾	T_{it}	135	_	-	°C
Thermal hysteresis	ΔT_{it}	_	10	_	K

¹higher current due temperature sensor

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²Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation

 $^{^3}$ see also $V_{\mbox{ON(CL)}}$ in circuit diagram

⁴ higher operating temperature at normal function available

Smart High-Side Power Switch BTS4141N

Electrical Characteristics

Parameter	Symbol		Values		
at $T_{\rm j}$ = -40125 °C, $V_{\rm bb}$ = 1530 V unless otherwise specified		min.	typ.	max.	
Input	,	,			,
Continuous input voltage ¹⁾	V_{IN}	-10 ²)	-	$V_{\rm bb}$	V
Input turn-on threshold voltage	$V_{IN(T+)}$	-	-	3.0	
Input turn-off threshold voltage	V _{IN(T-)}	1.82	-	-	
Input threshold hysteresis	$\Delta V_{\rm IN(T)}$	-	0.2	-	
Off state input current	/ _{IN(off)}				μΑ
$V_{\text{IN}} \leq 1.8 \text{ V}$		20	-	-	
On state input current	I _{IN(on)}	-	-	110	
Input delay time at switch on $V_{\rm bb}$	t _{d(Vbbon)}	150	340	-	μs
Input resistance (see page 8)	R_{I}	1.5	3	5	kΩ
	•	•			•
Reverse Battery	_				
Reverse battery voltage ³⁾²⁾	-V _{bb}				V

Reverse battery voltage ³⁾²⁾	-V _{bb}				V
$R_{GND} = 0 \ \Omega$		-	_	0.3	
R_{GND} = 150 Ω		-	-	45	
Continuous reverse drain current ²⁾	IS	-	-	1	Α
<i>T</i> _j = 25 °C					
Drain-source diode voltage ($V_{OUT} > V_{bb}$)	-V _{ON}	-	0.6	1.2	V
<i>I</i> _F = 1 A					

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 $^{^{1}}$ At $V_{\mbox{\footnotesize{IN}}}$ > Vbb, the input current is not allowed to exceed ±5 mA.

 $^{2 \}mathrm{not}$ subject to production test, guaranted by design

 $^{^{3}}$ defined by P_{tot}

Smart High-Side Power Switch BTS4141N

EMC-Characteristics

All EMC-Characteristics are based on limited number of sampels and no part of production test.

Test Conditions:

If not other specified the test circuitry is the minimal functional configuration without any external components for protection or filtering.

Supply voltage: $V_{bb} = 13.5V$ Temperature: $T_a = 23 \pm 5^{\circ}C$;

Load: $R_{\rm I} = 220\Omega$

Operation mode: PWM Frequency: 100Hz / Duty Cycle: 50%

DC On/Off

DUT-Specific.: R_{GND}

Fast electrical transients

Acc. ISO 7637

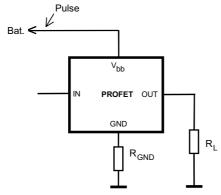
Test Pulse	Test Level	Test Results		Pulse Cycle Time and
		On	Off	Generator Impedance
1	-200 V	С	С	$500 \mathrm{ms}$; 10Ω
2	+200 V	С	С	$500 \mathrm{ms}$; 10Ω
3a	-200 V	С	С	100ms ; 50 Ω
3b	+ 200 V	С	С	100ms ; 50 Ω
41)	-7 V	С	С	0,01Ω
5	175 V	E (70V)	E (70V)	400ms ; 2Ω

The test pulses are applied at $V_{\rm bb}$

Definition of functional status

Class	Content
С	All functions of the device are performed as designed after exposure to disturbance.
Ε	One or more function of a device does not perform as designed after exposure
	and can not be returned to proper operation without repairing or replacing the
	device. The value after the character shows the limit.

Test circuit:



¹Supply voltage V_{bb} = 12 V instead of 13,5 V.

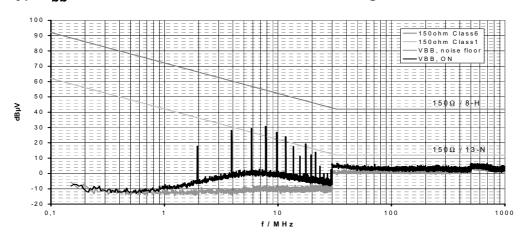
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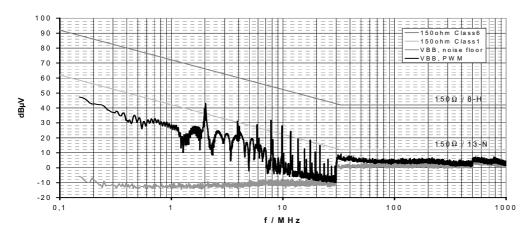
Conducted Emission

Acc. IEC 61967-4 (1Ω / 150Ω method)

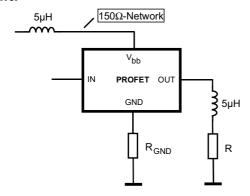
Typ. V_{bb} -Pin Emission at DC-On with 150 Ω -matching network



Typ. V_{bb} -Pin Emission at PWM-Mode with 150 Ω -matching network



Test circuit:



For defined decoupling and high reproducibility a defined choke ($5\mu H$ at 1 MHz) is inserted between supply and V_{bb} -pin.

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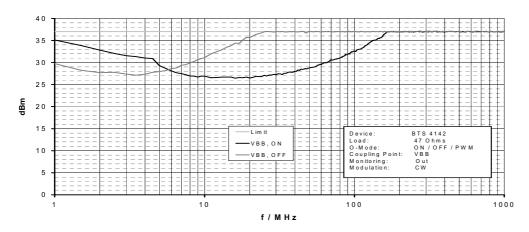
Conducted Susceptibility

Acc. 47A/658/CD IEC 62132-4 (Direct Power Injection)

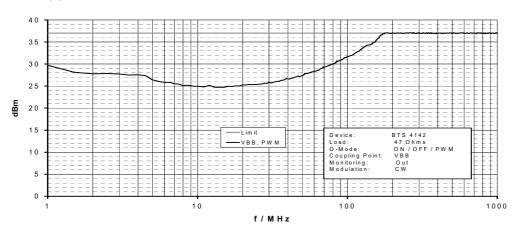
Direct Power Injection: Forward Power CW

Failure criteria: Amplitude and frequency deviation max. 10% at Out

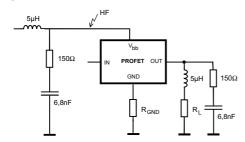
Typ. Vbb-Pin Susceptibility at DC-On/Off



Typ. V_{bb}-Pin Susceptibility at PWM-Mode



Test circuit:

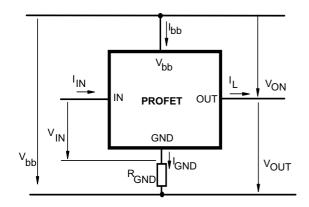


For defined decoupling and high reproducibility the same choke and the same 150Ω -matching network as for the emission measurement is used.

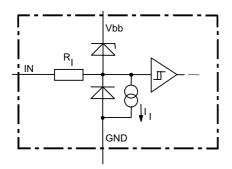
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Terms

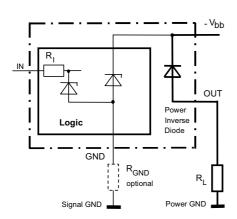


Input circuit (ESD protection)



The use of ESD zener diodes as voltage clamp at DC conditions is not recommended

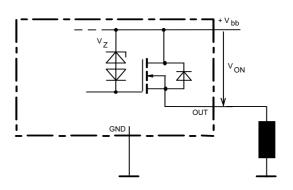
Reverse battery protection



 R_{GND} =150 Ω , R_{I} =3 $k\Omega$ typ.,

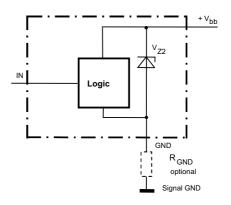
Temperature protection is not active during inverse current

Inductive and overvoltage output clamp



 V_{ON} clamped to 63 V min.

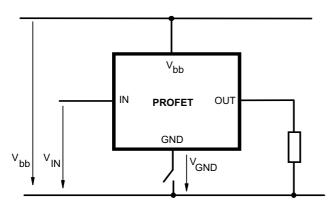
Overvoltage protection of logic part



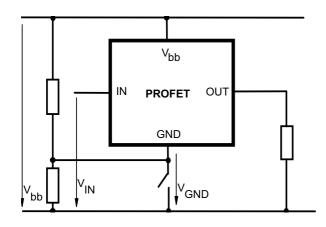
 V_{Z2} = $V_{bb(AZ)}$ =47V min., R=3 k Ω typ., R_{GND}=150 Ω



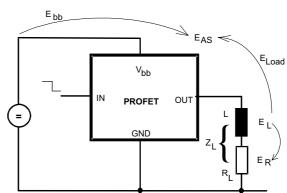
GND disconnect



GND disconnect with GND pull up



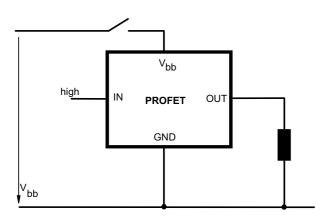
Inductive Load switch-off energy dissipation



Energy stored in load inductance: $E_L = \frac{1}{2} * L * I_L^2$ While demagnetizing load inductance, the energy dissipated in PROFET is $E_{AS} = E_{bb} + E_L - E_R = V_{ON(CL)} * i_L(t) dt$, with an approximate solution for $R_L > 0\Omega$:

$$E_{AS} = \frac{I_L * L}{2 * R_L} * (V_{bb} + |V_{OUT(CL)|}) * ln(1 + \frac{I_L * R_L}{|V_{OUT(CL)}|})$$

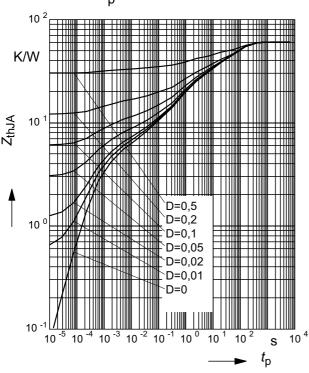
V_{bb} disconnect with charged inductive load





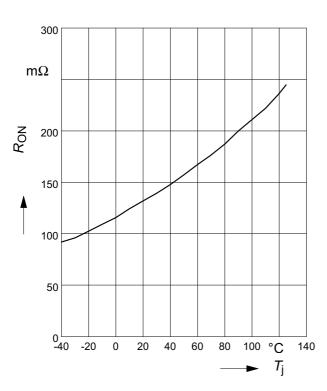
Typ. transient thermal impedance Z_{thJA} =f(t_{p}) @ 6cm² heatsink area

Parameter: $D=t_p/T$



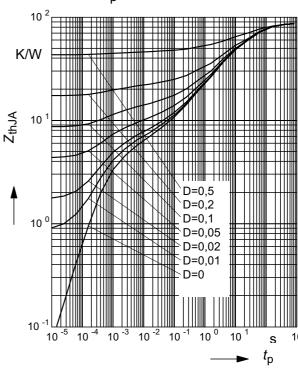
Typ. on-state resistance

$$R_{ON} = f(T_j)$$
; $V_{bb} = 15 \text{ V}$; $V_{in} = \text{high}$



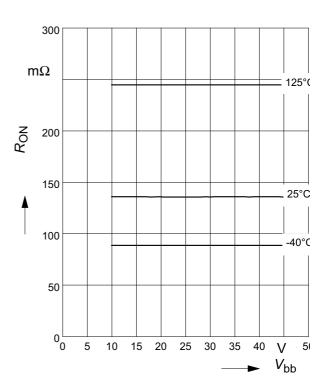
Typ. transient thermal impedance $Z_{\text{thJA}} = f(t_p)$ @ min. footprint

Parameter: $D=t_p/T$



Typ. on-state resistance

$$R_{ON} = f(V_{bb}); I_L = 0.5A; V_{in} = high$$

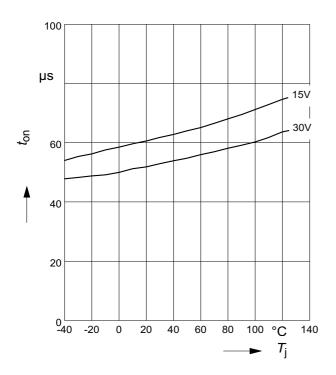


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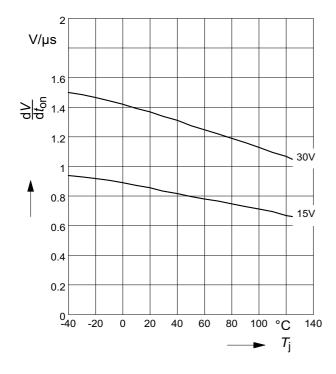


Typ. turn on time

$$t_{on} = f(T_j); R_L = 47\Omega$$

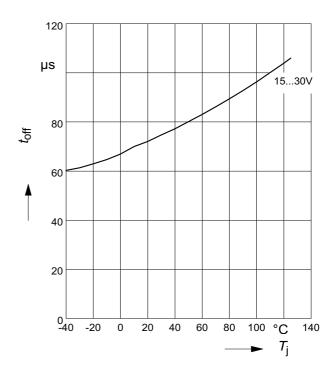


Typ. slew rate on $dV/dt_{on} = f(T_i)$; $R_L = 47 \Omega$



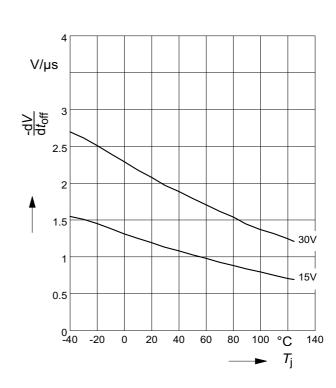
Typ. turn off time

$$t_{\text{off}} = f(T_j); R_L = 47\Omega$$



Typ. slew rate off

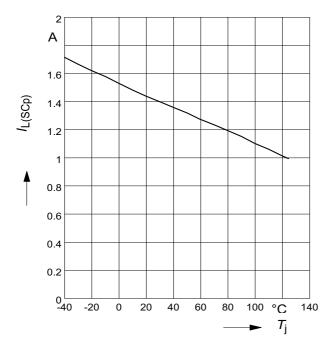
$$dV/dt_{off} = f(T_i)$$
; $R_L = 47 \Omega$



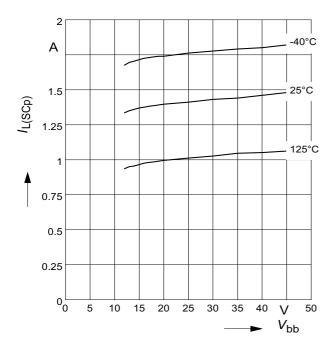
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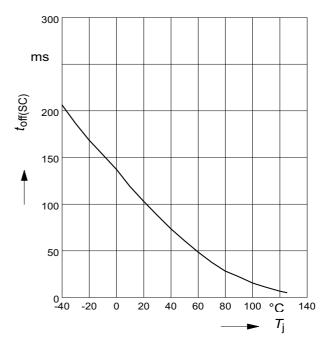
Typ. initial peak short circuit current limit $I_{L(SCp)} = f(T_j)$; $V_{bb} = 20V$; $t_m = 150 \mu s$



Typ. initial peak short circuit current limit $I_{L(SCp)} = f(V_{bb})$; $t_{m} = 150 \mu s$

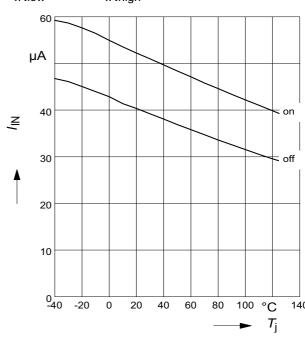


Typ. initial short circuit shutdown time $t_{\text{off(SC)}} = f(T_{j,\text{start}})$; $V_{\text{bb}} = 20 \text{V}$



Typ. input current

 $I_{IN(on/off)} = f(T_j); V_{bb} = 15 \text{ V}; V_{IN} = \text{low/high}$ $V_{INlow} \le 1.8 \text{V}; V_{INhigh} = 5 \text{V}$

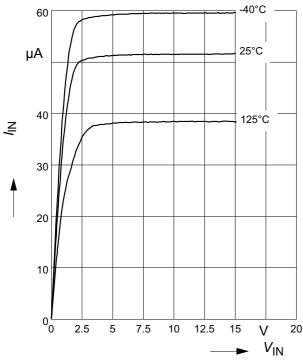


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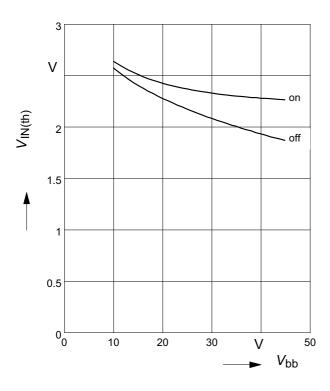
Typ. input current

$$I_{IN} = f(V_{IN}); V_{bb} = 15 \text{ V}$$



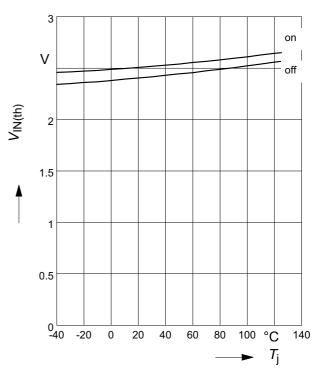
Typ. input threshold voltage

$$V_{IN(th)} = f(V_{bb})$$
; $T_j = 25$ °C



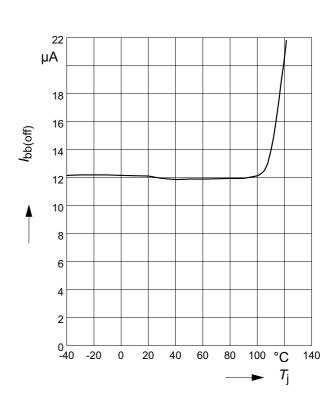
Typ. input threshold voltage

$$V_{IN(th)} = f(T_j) ; V_{bb} = 15 V$$



Typ. standby current

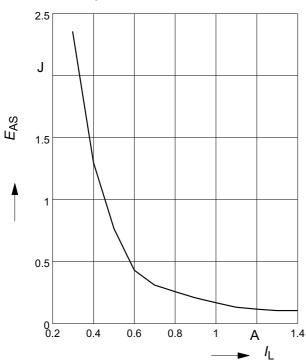
$$I_{bb(off)} = f(T_j)$$
; $V_{bb} = 32V$; $V_{IN} \le 1.2 V$



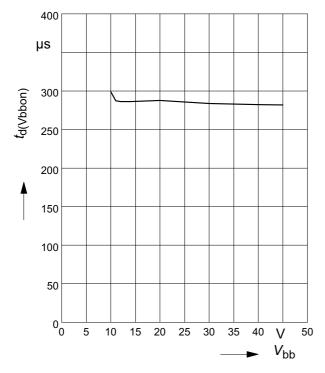


Maximum allowable inductive switch-off energy, single pulse

$$E_{AS} = f(I_L); T_{jstart} = 125$$
°C

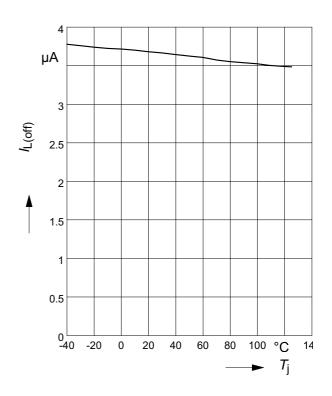


Typ. input delay time at switch on $V_{\rm bb}$ $t_{\rm d(Vbbon)}$ = f($V_{\rm bb}$)



Typ. leakage current

$$I_{L(off)} = f(T_j)$$
; $V_{bb} = 32V$; $V_{IN} \le 1.2 V$





Timing diagrams

Figure 1a: Vbb turn on:

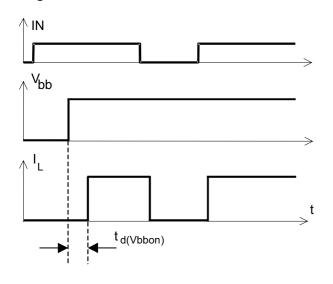


Figure 2b: Switching a lamp

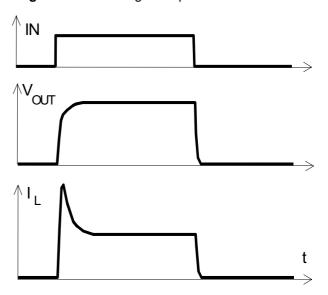


Figure 2a: Switching a resistive load, turn-on/off time and slew rate definition

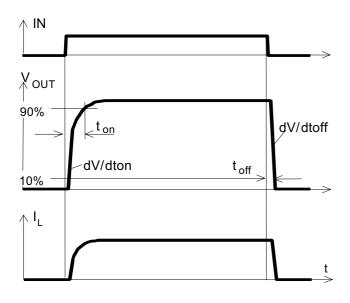
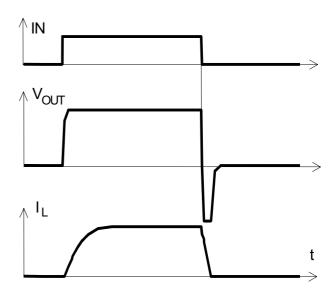


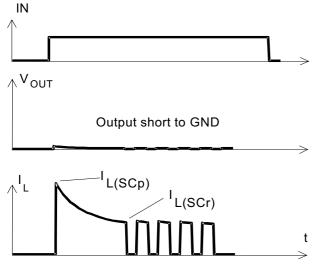
Figure 2c: Switching an inductive load



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Figure 3a: Turn on into short circuit, shut down by overtemperature, restart by cooling ...



Heating up of the chip may require several milliseconds, depending on external conditions.

Figure 4: Overtemperature: Reset if $T_i < T_{it}$

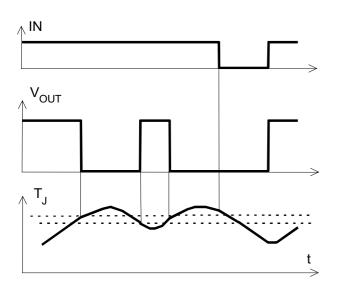


Figure 3b: Short circuit in on-state shut down by overtemperature, restart by cooling

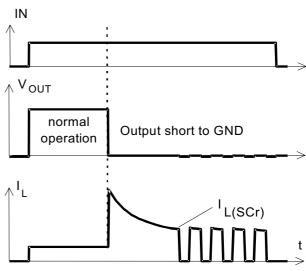
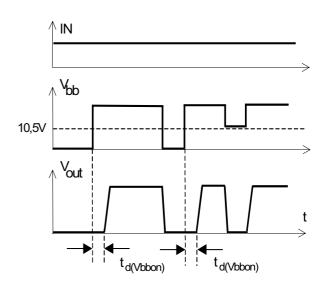


Figure 5: Undervoltage shutdown and restart





Package Outlines

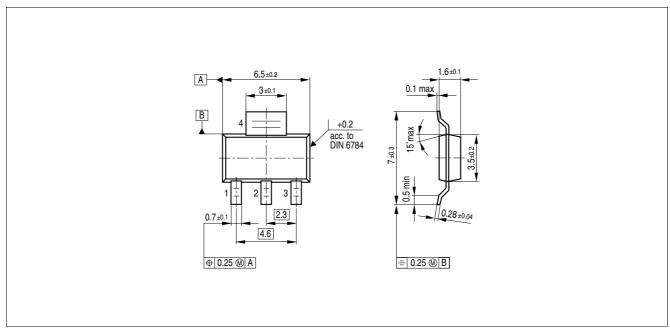


Figure 1 PG-SOT-223 (Plastic Dual Small Outline Package) (RoHS-compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Please specify the package needed (e.g. green package) when placing an order



Revision History

Version	Date	Changes
V1.1	2009-01-12	Creation of the green datasheet.
		First page :
		Adding the green logo and the AEC qualified
		Adding the bullet AEC qualified and the RoHS compliant features
		Package page
		Modification of the package to be green.

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